

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Nadia Ben Mohamed</td> <td>08/13/2010</td> </tr> <tr> <td>Daniel Delprat</td> <td>08/16/2010</td> </tr> <tr> <td>Ta Ko Chuang</td> <td>09/10/2010</td> </tr> <tr> <td>Jeffrey Scott Cites</td> <td>09/10/2010</td> </tr> <tr> <td>Alex Usenko</td> <td>09/10/2010</td> </tr> </tbody> </table>		Name	Execution Date	Nadia Ben Mohamed	08/13/2010	Daniel Delprat	08/16/2010	Ta Ko Chuang	09/10/2010	Jeffrey Scott Cites	09/10/2010	Alex Usenko	09/10/2010
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Alex Usenko	09/10/2010												
RECEIVING PARTY DATA													
Name:	Corning Incorporated												
Street Address:	SP-TI-03-1												
City:	Corning												
State/Country:	NEW YORK												
Postal Code:	14831												
PROPERTY NUMBERS Total: 1													
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13714792</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	13714792								
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CORRESPONDENCE DATA													
Fax Number:													
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>													
Phone:	607-974-0084												
Email:	tuckergl@corning.com												
Correspondent Name:	CORNING INCORPORATED												
Address Line 1:	SP-TI-3-1												
Address Line 4:	CORNING, NEW YORK 14831												
ATTORNEY DOCKET NUMBER:	SP10-162A												
NAME OF SUBMITTER:	Bruce P. Watson												
<p>Total Attachments: 4</p> <p>source=20100914_SP10-162A_US_Assignment#page1.tif</p> <p>source=20100914_SP10-162A_US_Assignment#page2.tif</p> <p>source=20100914_SP10-162A_US_Assignment#page3.tif</p> <p>source=20100914_SP10-162A_US_Assignment#page4.tif</p>													

CH \$40.00 13714792

ASSIGNMENT

FOR VALUE RECEIVED, I, as a below named inventor, hereby sell, assign and transfer unto S.O.I. TEC Silicon On Insulator Technologies, a corporation organized and existing under the laws of the France, having its principal place of business at Bernin France, (hereinafter SOITEC), as assignee, and unto its successors, assigns and legal representatives, the entire right, title and interest, for all countries, in and to certain inventions relating to a **SEMICONDUCTOR ON GLASS SUBSTRATE WITH STIFFENING LAYER AND PROCESS OF MAKING THE SAME**, such inventions being generally described in an application for Letters Patent of the United States executed on

DATE 8-13-2010
DATE 8-16-2010

and in any future patent applications claiming the benefit of the filing date of that application, and all the rights and privileges under any and all Letters Patents that may be granted therefore.

I request that any and all patents for said inventions be issued to SOITEC, its successors, assigns and legal representatives, or to such nominees as SOITEC may designate.

I agree that, when requested, I will, without charge to SOITEC and at SOITEC's expense, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable or convenient for securing and maintaining patents for said inventions in any and all countries and for vesting title thereto in SOITEC, its successors, assigns and legal representatives or nominees.

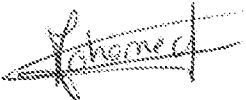
I authorize and empower SOITEC, its successors, assigns and legal representatives or nominees, to invoke and claim for any application for patent or other form of protection for said inventions filed by it or them, the benefit of the right of priority provided by the International Convention for the Protection of Industrial Property, as amended, or by any convention which may henceforth be substituted for said Convention or entered as a supplement to, and to invoke and claim such right of priority without further written or oral authorization.

I hereby consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any assignment, consent to file or like document which may be required in any country for any purpose and more particularly in proof of the right of SOITC, or its successors, assigns and legal representatives or nominees to claim the aforesaid benefit of the right of priority provided by the International Convention for the Protection of Industrial Property, as amended, or by any convention which may henceforth be substituted for it or entered as a supplement to it.

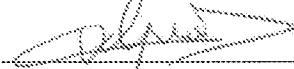
I covenant with SOITEC, its successors, assigns and legal representatives or nominees, that the rights and property herein conveyed are free and clear of any encumbrance, and that I have full right to convey the same as herein expressed.

Signed at Bernin, France, this

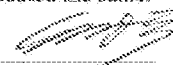
13/08/2010
Date


Nadia Ben Mohamed

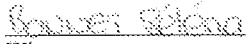
16/08/2010
Date


Daniel Delprat

On the 13 day of August 2010, before me personally came Nadia Ben Mohamed known to be the person described in and who executed the foregoing instrument, and acknowledged that they executed the same.


Enzo P. Girard
Witness

On the 16 day of August 2010, before me personally came Daniel Delprat known to be the person described in and who executed the foregoing instrument, and acknowledged that they executed the same.


Suzanne Selona
Witness

ASSIGNMENT

FOR VALUE RECEIVED, I, as a below named inventor, hereby sell, assign and transfer unto Corning Incorporated, a corporation organized and existing under the laws of the State of New York, having its principal place of business at Corning, New York, (hereinafter CORNING), as assignee, and unto its successors, assigns and legal representatives, the entire right, title and interest, for all countries, in and to certain inventions relating to a **SEMICONDUCTOR ON GLASS SUBSTRATE WITH STIFFENING LAYER AND PROCESS OF MAKING THE SAME**, such inventions being generally described in an application for Letters Patent of the United States executed on

DATE 9-10-2010
 DATE 9-10-2010
 DATE 9-10-2010

and in any future patent applications claiming the benefit of the filing date of that application, and all the rights and privileges under any and all Letters Patents that may be granted therefore.

I request that any and all patents for said inventions be issued to CORNING, its successors, assigns and legal representatives, or to such nominees as CORNING may designate.

I agree that, when requested, I will, without charge to CORNING and at CORNING's expense, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable or convenient for securing and maintaining patents for said inventions in any and all countries and for vesting title thereto in CORNING, its successors, assigns and legal representatives or nominees.

I authorize and empower CORNING, its successors, assigns and legal representatives or nominees, to invoke and claim for any application for patent or other form of protection for said inventions filed by it or them, the benefit of the right of priority provided by the International Convention for the Protection of Industrial Property, as amended, or by any convention which may henceforth be substituted for said Convention or entered as a supplement to, and to invoke and claim such right of priority without further written or oral authorization.

I hereby consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any assignment, consent to file or like document which may be required in any country for any purpose and more particularly in proof of the right of CORNING, or its successors, assigns and legal representatives or nominees to claim the aforesaid benefit of the right of priority provided by the International Convention for the Protection of Industrial Property, as amended, or by any convention which may henceforth be substituted for it or entered as a supplement to it.

I covenant with CORNING, its successors, assigns and legal representatives or nominees, that the rights and property herein conveyed are free and clear of any encumbrance, and that I have full right to convey the same as herein expressed.

Signed at Corning, NY, this

9/10/10
Date

Ta Ko Chuang
Ta Ko Chuang

9/10/2010
Date

Jeffrey Scott Cites
Jeffrey Scott Cites

9/10/2010
Date

Alex Usenko
Alex Usenko

State of New York)
: ss.
County of Steuben)

On the 10TH day of SEPTEMBER 2010, before me personally came Ta Ko Chuang known to be the person described in and who executed the foregoing instrument, and acknowledged that they executed the same.

Julie Henshaw
Notary Public
Julie Henshaw
Notary Public, State of New York
Qualified in Steuben County No. 01HE6201882
My Commission Expires March 9, 2013

State of New York)
: ss.
County of Steuben)

On the 10TH day of SEPTEMBER 2010, before me personally came Jeffrey Scott Cites known to be the person described in and who executed the foregoing instrument, and acknowledged that they executed the same.

Julie Henshaw
Notary Public
Julie Henshaw
Notary Public, State of New York
Qualified in Steuben County No. 01HE6201882
My Commission Expires March 9, 2013

State of New York)
: ss.
County of Steuben)

On the 10TH day of SEPTEMBER 2010, before me personally came Alex Usenko known to be the person described in and who executed the foregoing instrument, and acknowledged that they executed the same.

Julie Henshaw
Notary Public
Julie Henshaw
Notary Public, State of New York
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